GSE240LB1D3F

ESD Protection Diode

Product Description

It is designed to protect sensitive electronics from damage due to electrostatic discharge (ESD) and other transient events.

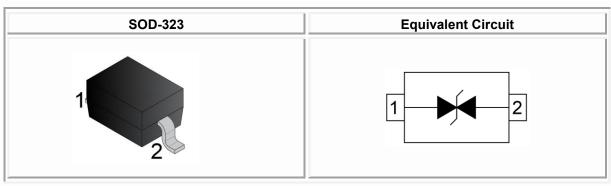
Features

- Operating Voltage: 24V
- IEC61000-4-2(ESD) ±30kV (Air)
- IEC61000-4-2(ESD) ±30kV (Contact)
- IEC61000-4-4 (EFT) 40A (5/50ns).
- IEC61000-4-5 (Lightning) 7A (8/20µs).

Mechanical Data

- SOD-323. Package
- RoHS Compliant and Halogen Free

Package and Pin Assignment





Ordering and Marking Information

GS P/N	Package	Marking	Quantity / Reel	
GSE240LB1D3F	SOD-323	24B	3,000PCS	
GSE240LB1D3F - Product Code: GSE240LB1	Product Code: - Package Code: - Green Level:			
	Marking	Information		
24B	- Product Code 24B	9 :		

Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
P _{PP}	Peak Pulse Power (t _P =8/20μs)	350	W
Ірр	Peak Pulse Current (t⊳=8/20µs)	7	Α
.,,	ESD Per IEC61000-4-2 (Air)	±30	KV
VESD	ESD Per IEC61000-4-2 (Contact)	±30	KV
TJ	Operating Junction Temperature Range	-55 to +150	°C
Tstg	Storage Temperature Range	-55 to +150	°C
TL	Lead Soldering Temperature	260 (10 sec.)	°C

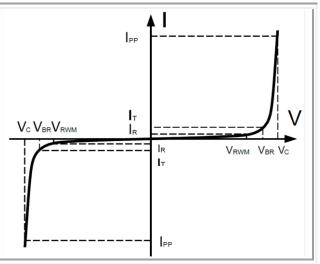


Electrical Characteristics (T_A=25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{RWM}	Reverse Working Voltage	-			24	V
V _{BR}	Breakdown Voltage	I _T = 1mA	26.7			V
I _R	Reverse Leakage Current	V _{RWM} =24V			0.2	μА
Vc	Clamping Voltage	I _{PP} =7А (8/20µs)		40	45	V
Сл	Junction Capacitance	V _R =0V, f=1MHz		20	25	pF

Electrical Parameters

Symbol	Parameter	
Ірр	Reverse Peak Pulse Current	
Vc	Clamping Voltage @ IPP	
V _{RWM}	Reverse Stand-Off Voltage	
I _R	Reverse Leakage Current @ V _{RWM}	
V _{BR}	Breakdown Voltage @ I⊤	
lτ	Test Current	





Typical Characteristics (T_A=25°C unless otherwise specified)

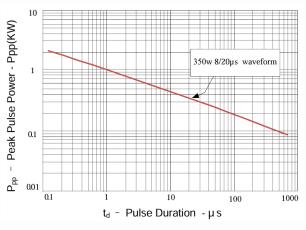


FIG 1. Peak Pulse Power vs. Pulse Time

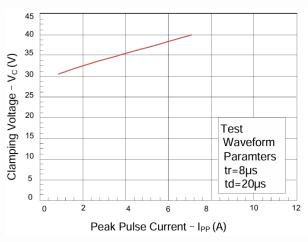


FIG 3. Clamping Voltage vs. Peak Pulse Current

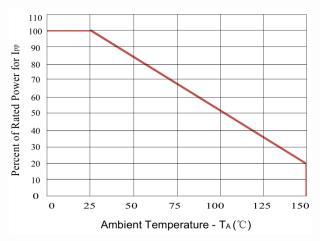


FIG 2. Power Derating Curve

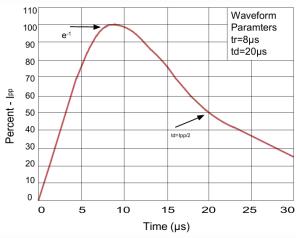


FIG 4. Pulse Waveform

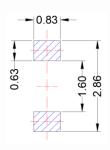


SOD-323

Package Dimension

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Recommended Land Pattern



Unit:mm

	Dimensions				
Cymahal	Millimeters		Inches		
Symbol	MIN	MAX	MIN	MAX	
Α		1.16		0.046	
A1	0.00	0.14	0.000	0.006	
A2	0.80		0.031		
b	0.25	0.40	0.010	0.016	
С	0.08	0.25	0.003	0.010	
D	1.15	1.40	0.045	0.055	
Е	2.30	2.80	0.091	0.110	
E1	1.40	1.80	0.055	0.071	
L	0.08		0.003		
θ	0°	8°	0°	8°	

NOTE:

Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



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CONTACT US

	GS Headquarter
	4F, NO.43-1, Lane 11, Sec. 6, Minquan E. Rd Neihu District, Taipei City 114761, Taiwan (R.O.C).
6	886-2-2657-9980
	886-2-2657-3630
@	sales_twn@gs-power.com

	RD Division
\\\\!	824 Bolton Drive Milpitas. CA. 95035
E	1-408-457-0587

